# INTEGRATED CIRCUITS

# DATA SHEET

# TDA3856 Quasi-split sound processor for all standards

Product specification
File under Integrated Circuits, IC02

June 1994







# Quasi-split sound processor for all standards

**TDA3856** 

### **FEATURES**

- Quasi-split sound processor for all standards e. g. B/G (FM sound) and L (AM sound)
- Automatic muting of the AF2 signal (at B/G) by the input level
- AM signal processing for L standard and switching over the audio signal
- Layout-compatible with TDA3858 (32 pins) and TDA3857 (20 pins).

### **GENERAL DESCRIPTION**

Separate symmetrical IF inputs for FM or AM sound.

Gain controlled wideband IF amplifier, input select switch. AGC generation due to peak sync for FM or mean signal level for AM. Reference amplifier for the regeneration of the vision carrier. Optimized limiting amplifier for AM suppression in the regenerated vision carrier signal and 90° phase shifter. Intercarrier mixer for FM sound, output with low-pass filter. Separate signal processing for 5.5 and 5.74 MHz intercarriers. Wide supply voltage range, only 300 mW power dissipation at 5 V.

### QUICK REFERENCE DATA

| SYMBOL              | PARAMETER                        | MIN. | TYP. | MAX. | UNIT |
|---------------------|----------------------------------|------|------|------|------|
| V <sub>P</sub>      | supply voltage (pin 21)          | 4.5  | 5    | 8.8  | V    |
| I <sub>P</sub>      | supply current                   | _    | 60   | 72   | mA   |
| V <sub>i IF</sub>   | IF input sensitivity (–3 dB)     | _    | 70   | 100  | μV   |
| V <sub>o(RMS)</sub> | audio output signal for FM (B/G) | _    | 1    | _    | V    |
| V <sub>o(RMS)</sub> | audio output signal for AM (L)   | _    | 0.6  | _    | ٧    |
| THD                 | total harmonic distortion        |      |      |      |      |
|                     | for FM                           | _    | 0.5  | _    | %    |
|                     | for AM                           | _    | 1    | _    | %    |
| S/N (W)             | weighted signal-to-noise ratio   |      |      |      |      |
|                     | for FM                           | _    | 68   | _    | dB   |
|                     | for AM                           | _    | 56   | _    | dB   |

# **ORDERING INFORMATION**

| EXTENDED    |      |                 | PACKAGE  |                       |
|-------------|------|-----------------|----------|-----------------------|
| TYPE NUMBER | PINS | PIN<br>POSITION | MATERIAL | CODE                  |
| TDA3856     | 24   | shrink DIL      | plastic  | SOT234 <sup>(1)</sup> |
| TDA3856T    | 24   | SO              | plastic  | SOT137 <sup>(2)</sup> |

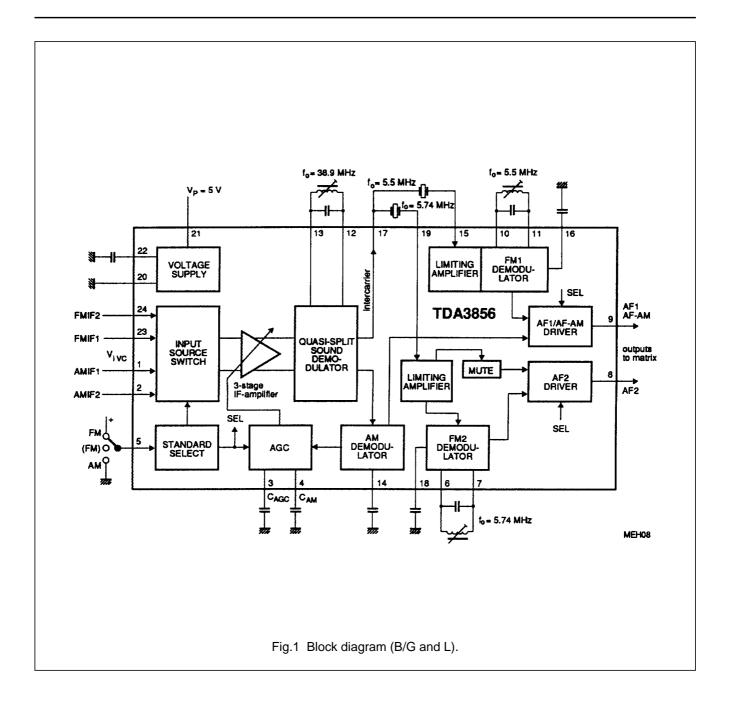
### Note

1. SOT234-1; 1996 November 28.

2. SOT137-1; 1996 November 28.

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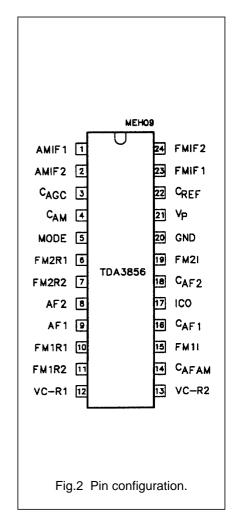
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# **PINNING**

| SYMBOL            | PIN | DESCRIPTION   |
|-------------------|-----|---|
| AMIF1             | 1   | AM IF difference input 1 for L standard (32.4 MHz)  |
| AMIF2             | 2   | AM IF difference input 2 for L standard (32.4 MHz)  |
| C <sub>AGC</sub>  | 3   | charge capacitor for AGC (FM and AM)                |
| C <sub>AM</sub>   | 4   | charge capacitor for AM AGC                         |
| MODE              | 5   | 3-state input for standard select                   |
| FM2R1             | 6   | reference circuit for FM2 (5.74 MHz)                |
| FM2R2             | 7   | reference circuit for FM2 (5.74 MHz)                |
| AF2               | 8   | AF2 output (AF out of 5.74 MHz)                     |
| AF1               | 9   | AF1 output (AF out of 5.5 MHz or AM)                |
| FM1R1             | 10  | reference circuit for FM1 (5.5 MHz)                 |
| FM1R2             | 11  | reference circuit for FM1 (5.5 MHz)                 |
| VC-R1             | 12  | reference circuit for the vision carrier (38.9 MHz) |
| VC-R2             | 13  | reference circuit for the vision carrier (38.9 MHz) |
| C <sub>AFAM</sub> | 14  | DC decoupling capacitor for AM demodulator (AF-AM)  |
| FM1               | 15  | intercarrier input for FM1 (5.5 MHz)                |
| C <sub>AF1</sub>  | 16  | DC decoupling capacitor for FM1 demodulator (AF1)   |
| ICO               | 17  | intercarrier output signal (5.5/5.74 MHz)           |
| C <sub>AF2</sub>  | 18  | DC decoupling capacitor for FM2 demodulator (AF2)   |
| FM2I              | 19  | intercarrier input for FM2 (5.74 MHz)               |
| GND               | 20  | ground (0 V)  |
| V <sub>P</sub>    | 21  | +5 to +8 V supply voltage                           |
| C <sub>REF</sub>  | 22  | charge capacitor for reference voltage              |
| FMIF1             | 23  | IF difference input 1 for B/G standard (38.9 MHz)   |
| FMIF2             | 24  | IF difference input 2 for B/G standard (38.9 MHz)   |



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### **FUNCTIONAL DESCRIPTION**

The quasi-split sound processor is suitable for all standards.

Dependent on the voltage at pin 5 either FM mode (B/G) or AM mode (L) is selected.

### B/G standard (FM mode)

Pins 23 and 24 are active, AGC detector uses peak sync level. Sound carrier SC1 (5.5 MHz) provides AF1, sound carrier SC2 (5.74 MHz) provides AF2.

### Muting

With no sound carrier SC2 at pin 19, AF2 output is muted (in mid-position of the standard select switch FM mode without muting of AF2 is selected).

The mute circuit prevents false signal recognition in the stereo decoder at high IF signal levels when no second sound carrier exists (mono) and an AF signal is present in the identification signal frequency range.

With 1 mV at pin 19, under measurement conditions, AF2 is switched on (see limiting amplifier). Weak input signals at pins 23 and 24 generate noise at pin 19, which is present in the intercarrier signal and passes through the 5.74 MHz filter. Noise at pin 19 inhibits muting. No misinterpretation due to white noise occurs in the stereo decoder, when non-correlated noise masks the identification signal frequencies, which may be present in sustained tone signals. The stereo decoder remains switched to mono.

# L standard (AM mode)

Pins 1 and 2 are active, AGC detector uses mean signal level. The audio signal from the AM demodulator is output on AF1, with AF2 output muted.

# Sound carrier notch filter for an improved intercarrier buzz

The series capacitor  $C_s$  in the 38.9 MHz resonant circuit provides a notch at the sound carrier frequency in order to provide more attenuation for the sound carrier in the vision carrier reference channel. The ratio of parallel/series capacitor depends on the ratio of VC/SC frequency and has to be adapted to other TV transmission standards if necessary, according to the formula  $C_s = C_P \ (f_{vo}/f_{sc})^2 - C_P$ . The result is an improved intercarrier buzz (up to 10 dB improvement in sound channel 2 with 250 kHz video modulation for B/G stereo) or suppression of 350 kHz video modulated beat frequency in the digitally-modulated NICAM subcarrier.

# Intercarrier buzz fine tuning with 250 kHz square wave video modulation

The picture carrier for quadrature demodulation in the intercarrier mixer is not exactly 90 degrees due to the shift variation in the integrated phase shift network. The tuning of the LC reference circuit to provide optimal video suppression at the intercarrier output is not the same as that to provide optimal intercarrier buzz suppression. In order to optimize the AF signal performance, a fine tuning for the optimal S/N at the sound channel 2 (from 5.74 MHz) may be performed with a 250 kHz square wave video modulation.

# Measurements at the demodulators

For all signal-to-noise measurements the generator must meet the following specifications: phase modulation errors  $< 0.5^{\circ}$  for B/W-jumps

intercarrier signal-to-noise ratio as measured with 'TV-demodulator AMF2' (weighted S/N) must be > 60 dB at 6 kHz sine wave modulation of the B/W-signal. Signal-to-noise ratios are measured with  $\Delta f=\pm 50$  kHz deviation and  $f_{mod}=1$  kHz; with a deviation of  $\pm 30$  kHz the S/N ratio is deteriorated by 4.5 dB.

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# **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL           | PARAMETER   | MIN. | MAX.           | UNIT |
|------------------|---|------|----------------|------|
| V <sub>P1</sub>  | supply voltage (pin 21)                             | _    | 8.8            | V    |
| VI               | voltage (pins 1, 2, 5, 8, 9, 15, 17, 19, 23 and 24) | 0    | V <sub>P</sub> | V    |
| P <sub>tot</sub> | total power dissipation                             | 0    | 650            | mW   |
| T <sub>stg</sub> | storage temperature                                 | -25  | +150           | °C   |
| T <sub>amb</sub> | operating ambient temperature                       | 0    | +70            | °C   |
| V <sub>ESD</sub> | electrostatic handling (note 1)                     |      |                |      |
|                  | all pins except pins 1, 2, 23 and 24                | ±500 | _              | V    |
|                  | pins 1, 2, 23 and 24                                | +400 | _              | V    |
|                  |   | -500 | _              | V    |

# Note to the Limiting Values

1. Equivalent to discharging a 200 pF capacitor through a 0  $\Omega$  series resistor.

### **CHARACTERISTICS**

 $V_P = 5$  V and  $T_{amb} = +25$  °C; measurements taken in Fig.3 with  $f_{vc} = 38.9$  MHz,  $f_{SC1} = 33.4$  MHz and  $f_{SC2} = 33.158$  MHz. Vision carrier (VC) modulated with different video signals, modulation depth 100% (proportional to 10% residual carrier).

Vision carrier amplitude (RMS value)  $V_{i \ VC}$  = 10 mV; vision to sound carrier ratios are VC/SC1 = 13 dB and VC/SC2 = 20 dB. Sound carriers (SC1, SC2) modulated with f = 1 kHz and deviation  $\Delta f$  = 50 kHz, unless otherwise specified.

| SYMBOL             | PARAMETER                                  | CONDITIONS  | MIN. | TYP. | MAX.  | UNIT |
|--------------------|--|---|------|------|-------|------|
| V <sub>P</sub>     | supply voltage (pin 21)                    |   | 4.5  | 5    | 8.8   | V    |
| I <sub>P</sub>     | supply current (pin 21)                    |   | 48   | 60   | 72    | mA   |
| IF source co       | ontrol (pin 5)                             | •   | ·    | •    |       |      |
| V <sub>5</sub>     | input voltage in order to obtain standards |   |      |      |       |      |
|                    | B/G (FM) with automatic muting             | pin 5 connected   | 2.8  | _    | $V_P$ | V    |
|                    |  | pin 5 open-circuit  | _    | 2.8  | _     | V    |
|                    | B/G (FM) without muting                    | pin 5 connected or alternative measure: $22 \text{ k}\Omega$ to GND | 1.3  | _    | 2.3   | V    |
|                    | L (AM sound)                               | pin 5 connected   | 0    | _    | 0.8   | V    |
| I <sub>5</sub>     | input current                              | $V_5 = V_P$   | _    | _    | 100   | μΑ   |
|                    |  | $V_5 = 0 \text{ V}$   | _    | _    | -300  | μΑ   |
| IF input not       | activated (pins 1-2 or 23-24)              |   |      |      |       |      |
| R <sub>I</sub>     | input resistance                           |   | _    | _    | 100   | Ω    |
| VI                 | DC input voltage (pins 1, 2 or 23, 24)     | LOW set internally  | _    | _    | 0.1   | V    |
| α <sub>12-13</sub> | crosstalk attenuation of IF input switch   | note 1  | 50   | 56   | -     | dB   |
| IF amplifier       | (pins 1-2 or 23-24)                        |   | •    | •    |       |      |
| R <sub>I</sub>     | input resistance                           |   | 1.8  | 2.2  | _     | kΩ   |
| C <sub>I</sub>     | input capacitance                          |   | _    | 2.0  | 2.6   | pF   |

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| SYMBOL                            | PARAMETER   | CONDITIONS   | MIN.     | TYP.               | MAX. | UNIT |
|-----------------------------------|---|--|----------|--------------------|------|------|
| VI                                | DC potential, voltage (pins 1, 2, 23, 24)                     |  | _        | 1.75               | _    | V    |
| V <sub>i IF (RMS)</sub>           | maximum input signal (RMS value)                              | $V_0 = +1 \text{ dB}$  | 70       | 100                | _    | mV   |
|                                   | input signal sensitivity B/G standard (RMS value, pins 32-24) | -3 dB intercarrier signal reduction at pin 17                        | _        | 70                 | 100  | μV   |
|                                   | input signal sensitivity L standard (RMS value, pins 1-2)     | -3 dB intercarrier signal reduction at pin 9                         | _        | 70                 | 100  | μV   |
| V <sub>3</sub>                    | voltage for gain control (pin 3)                              |  | 1.7      | _                  | 2.6  | V    |
| $\Delta G_v$                      | IF gain control   |  | 60       | 63                 | _    | dB   |
| В                                 | IF bandwidth  | –3 dB  | 50       | 70                 | _    | MHz  |
| Resonance                         | amplifier (pins 12-13)  |  |          |                    |      |      |
| V <sub>o (p-p)</sub>              | vision carrier amplitude (peak-to-peak value)                 | f <sub>o</sub> = 38.9 MHz  | _        | 270                | _    | mV   |
| R <sub>12-13</sub>                | operating resistance  |  | _        | 4                  | _    | kΩ   |
| L                                 | inductance  | Figs 3 and 5   | _        | 0.247              | _    | μН   |
| С                                 | capacitance   |  | _        | 68                 | _    | pF   |
| $Q_L$                             | Q-factor of resonant circuit                                  | Q <sub>0</sub> = 90  | _        | 40                 | _    |      |
| V <sub>12, 13</sub>               | DC voltage (pins 12 and 13)                                   |  | _        | V <sub>P</sub> - 1 | _    | V    |
|                                   | mixer output (pin 17)   | -  | <b>'</b> |                    |      | !    |
| V <sub>o (RMS)</sub>              | output signal for 5.5 MHz (RMS value)                         |  | 71       | 95                 | 125  | mV   |
| , ,                               | output signal for 5.74 MHz (RMS value)                        |  | 32       | 43                 | 56   | mV   |
| В                                 | IF bandwidth  | -1 dB  | 6        | 8.5                | _    | MHz  |
|                                   |   | -3 dB  | 7        | 10                 | _    | MHz  |
| V <sub>VID</sub> /V <sub>17</sub> | residual video AM on intercarrier                             | note 2   | _        | 3                  | 10   | %    |
| V <sub>VC(RMS</sub> )             | residual vision carrier (RMS value)                           | 1st/2nd harmonic<br>(38.9/77.8 MHz)                                  | _        | 0.5                | 1    | mV   |
| R <sub>17</sub>                   | output resistance (emitter follower)                          | 1 mA emitter current   | _        | 30                 | _    | Ω    |
| Io                                | allowable AC output current (pin 17)                          |  | _        | _                  | ±0.7 | mA   |
| I <sub>17</sub>                   | allowable DC output current                                   |  | _        | _                  | -2   | mA   |
| V <sub>17</sub>                   | DC voltage  | LC-circuit at pin 12, 13 adjusted to minimum video content at pin 17 | 1.5      | 1.75               | 2.0  | V    |
| Limiting an                       | nplifiers (pins 15 and 19)                                    |  |          |                    |      |      |
| V <sub>i (RMS)</sub>              | minimum input signal (RMS value)                              | -3 dB AF signal  | _        | 300                | 450  | μV   |
| -/                                | maximum input signal (RMS value)                              |  | 200      | _                  | _    | mV   |
| R <sub>15, 19</sub>               | input resistance  |  | 450      | 560                | 700  | Ω    |
| V <sub>15, 19</sub>               | DC voltage  |  | _        | 0                  | _    | V    |
| V <sub>i (RMS)</sub>              | level detector threshold for no muting (RMS value, pin 19)    | only 5.74 MHz channel  | 0.8      | 1.2                | 1.7  | mV   |
| $\Delta V_i$                      | hysteresis of level detector                                  |  | 4        | 7                  | 12   | dB   |

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| SYMBOL  | PARAMETER   | CONDITIONS                               | MIN.                  | TYP.                 | MAX.     | UNIT  |
|---|---|--|-----------------------|----------------------|----------|-------|
| FM1 and FN                                    | // demodulators   |  | '                     |                      |          | '     |
| $\Delta f = \pm 50 \text{ kHz}$<br>De-emphasi | nts with FM IF input signals of 5.5 MHz and $z$ ) at pins 15 and 19 without ceramic filters, F s 50 $\mu$ s and V <sub>5</sub> = V <sub>P</sub> (B/G standard).  11 for resonant circuits at pins 6-7 and 10-11 | $R_s = 50 \Omega.$                       | 10 mV (f <sub>m</sub> | <sub>od</sub> = 1 kl | Hz, devi | ation |
| V <sub>IC (RMS)</sub>                         | intercarrier signals (RMS values, pins 6-7 and 10-11)   |  |                       | 100                  | _        | mV    |
| V   | DC voltage (pins 6, 7, 10 and 11)   |  | _                     | 1.8                  | _        | V     |
| V <sub>o(RMS)</sub>                           | AF output signals (RMS values, pins 8 and 9)  |  | 0.84                  | 0.95                 | 1.07     | V     |
| $\Delta V_{o}$                                | difference of AF signals between channels (pins 8 and 9)  |  | -                     | -                    | 1        | dB    |
| R <sub>8, 9</sub>                             | output resistance   |  | 75                    | 100                  | 130      | Ω     |
| V <sub>8, 9</sub>                             | DC voltage  |  | 1.8                   | 2.1                  | 2.4      | V     |
| I <sub>8, 9(M)</sub>                          | allowed AC current of emitter output (peak value)   | note 3                                   | -                     | -                    | ±1.5     | mA    |
| I <sub>8, 9</sub>                             | maximum allowed DC output current   |  | _                     | _                    | -2       | mA    |
| THD   | total harmonic distortion   |  | _                     | 0.5                  | 1.0      | %     |
| V <sub>o(RMS)</sub>                           | AF output signal (RMS value)  | THD = 1.5%                               | 1.25                  | -                    | _        | V     |
| $\alpha_{AM}$                                 | AM suppression  | 1 kHz; m = 0.3                           | 48                    | 54                   | _        | dB    |
| S/N(W)  | weighted signal-to-noise ratio  | CCIR468-3                                | 64                    | 68                   | _        | dB    |
| В   | AF bandwidth (-3 dB)  |  |                       |                      |          |       |
|   | lower limit   |  | -                     | _                    | 20       | Hz    |
|   | upper limit   |  | 100                   | _                    | _        | kHz   |
| $\alpha_{CR}$                                 | crosstalk attenuation (pins 9-8)  |  | 60                    | 70                   | _        | dB    |
| V <sub>16, 18</sub>                           | DC voltage (pins 16 and 18)   |  | _                     | 1.8                  | _        | V     |
| AM demodu                                     | <b>Lilator</b> $V_5 = 0 \text{ V (AM mode)}$  |  |                       | •                    |          | •     |
| input signals                                 | s at pins 1-2: SC = 32.4 MHz; f <sub>mod</sub> = 1 kHz; n   | n = 0.8; V <sub>i AM (RMS)</sub> = 10 m\ | /                     |                      |          |       |
| V <sub>o (RMS)</sub>                          | AF output signal at pin 9 (RMS value)   |  | 530                   | 600                  | 675      | mV    |
| R <sub>9</sub>                                | output resistance (pin 9)   |  | 75                    | 100                  | 130      | Ω     |
| I <sub>o (M)</sub>                            | maximum AC output current (peak value)  | note 3                                   | _                     | _                    | ±1.5     | mA    |
| l <sub>9</sub>                                | maximum DC output current   |  | _                     | _                    | -2       | mA    |
| V <sub>9</sub>                                | DC voltage  |  | 1.8                   | 2.1                  | 2.4      | V     |
| THD   | total harmonic distortion   | Fig.4                                    | _                     | 1                    | 2        | %     |
| S/N(W)  | weighted signal-to-noise ratio  | CCIR468-3                                | 50                    | 56                   | _        | dB    |
| В   | AF bandwidth (-3 dB)  |  |                       |                      |          |       |
|   | lower limit   |  | _                     | _                    | 20       | Hz    |
|   | upper limit   |  | 100                   | _                    | _        | kHz   |
| V <sub>14</sub>                               | DC voltage (pin 14)   |  | -                     | 2                    | _        | V     |

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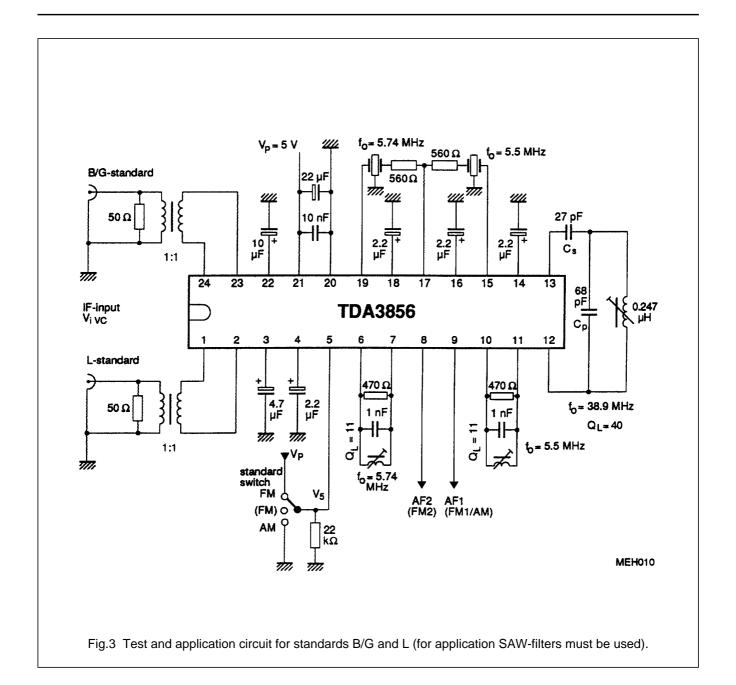
| SYMBOL                             | PARAMETER   | CONDITIONS   | MIN. | TYP. | MAX. | UNIT |
|------------------------------------|---|--|------|------|------|------|
| AF signal s                        | witches   |  | 1    | •    | •    | '    |
| input signals                      | s: AM carrier into pin 1, 2   | see part AM demodulator  |      |      |      |      |
|                                    | FM intercarrier into pin 15   | see part FM demodulator  |      |      |      |      |
|                                    | no signal in pin 19 (AF2)   |  |      |      |      |      |
| the output si                      | gnals are related to the signals described in   | n the demodulator parts.   |      |      |      |      |
| V <sub>o</sub> /V <sub>omute</sub> | AF2 mute attenuation (pin 8)  | B/G mode; V <sub>5</sub> = V <sub>P</sub>  | 70   | _    | _    | dB   |
| V <sub>oAM</sub> /V <sub>oFM</sub> | AF1 FM signal (pin 9) attenuation of unwanted FM signal   | L mode; V <sub>5</sub> = 0;<br>FM: modulated;<br>AM: unmodulated                 | 70   | _    | _    | dB   |
| V <sub>oFM</sub> /V <sub>oAM</sub> | AF1 AM signal (pin 9) attenuation of unwanted AM signal   | B/G mode; V <sub>5</sub> = V <sub>P</sub> ;<br>FM: unmodulated;<br>AM: modulated | 70   | _    | _    | dB   |
| dV <sub>8, 9</sub>                 | DC jump at the AF outputs   | switching to FM or AM sound or Mute  | _    | 5    | 25   | mV   |
| AF perform                         | ance for FM operation (standard B/G)  |  |      |      |      |      |
| input signals                      | s: B/G IF input signal (pin 23, 24)   |  |      |      |      |      |
|                                    | unmodulated sound carriers  |  |      |      |      |      |
|                                    | different video modulation (100%)   |  |      |      |      |      |
| the output si                      | gnals are related to the signals described in   | n the demodulator parts.   |      |      |      |      |
| (S+N)/N(W)                         | weighted signal-to-noise ratio  | CCIR468-3;<br>de-emphasis 50 μs  |      |      |      |      |
|                                    | black picture   | f <sub>i</sub> = 5.5 MHz   | 59   | 63   | _    | dB   |
|                                    | 2T/20T pulses with white bar  | f <sub>i</sub> = 5.5 MHz   | 57   | 61   | _    | dB   |
|                                    | 6 kHz sine wave, B/W-modulated  | f <sub>i</sub> = 5.5 MHz   | 52   | 56   | _    | dB   |
|                                    | 250 kHz square wave, B/W-modulated  | f <sub>i</sub> = 5.5 MHz   | 50   | 54   | _    | dB   |
|                                    | black picture   | f <sub>i</sub> = 5.742 MHz   | 57   | 61   | _    | dB   |
|                                    | 2T/20T pulses with white bar  | f <sub>i</sub> = 5.742 MHz   | 55   | 59   | _    | dB   |
|                                    | 6 kHz sine wave, B/W-modulated  | f <sub>i</sub> = 5.742 MHz   | 50   | 54   | _    | dB   |
|                                    | 250 kHz square wave, B/W-modulated  | f <sub>i</sub> = 5.742 MHz   | 48   | 52   | _    | dB   |
| Ripple reject                      | ction of the AF outputs (B/G and L stand  | ard)   |      |      |      |      |
| RR                                 | ripple rejection<br>V <sub>ripple</sub> on V <sub>P</sub> / V <sub>ripple</sub> on V <sub>out</sub> | $V_{R(p-p)} = 200 \text{ mV};$<br>$f_R = 70 \text{ Hz}$                          | 30   | 40   | _    | dB   |
|                                    |   | -  | -    | •    | •    | •    |

# Notes to the characteristics

- 1. Crosstalk attenuation of IF input switch, measured at  $R_{12-13} = 470 \,\Omega$  (instead of LC circuit); input signal  $V_{i \, (RMS)} = 20 \,\text{mV}$  (pins 23-24). AGC voltage  $V_3$  set to a value to achieve  $V_{o \, (RMS)} = 20 \,\text{mV}$  (pins 12-13). After switching ( $V_5 = 0 \,\text{V}$ ) measure attenuation. IF coupling with OFWG3203 and OFWL9350 (Siemens).
- 2. Spurious intercarrier AM: m = (A B)/A (A = signal at sync; B = signal with 100% picture modulation).
- 3. For larger current:  $R_L > 2.2 \text{ k}\Omega$  (pin 8 or 9 to GND) in order to increase the bias current of the output emitter follower.

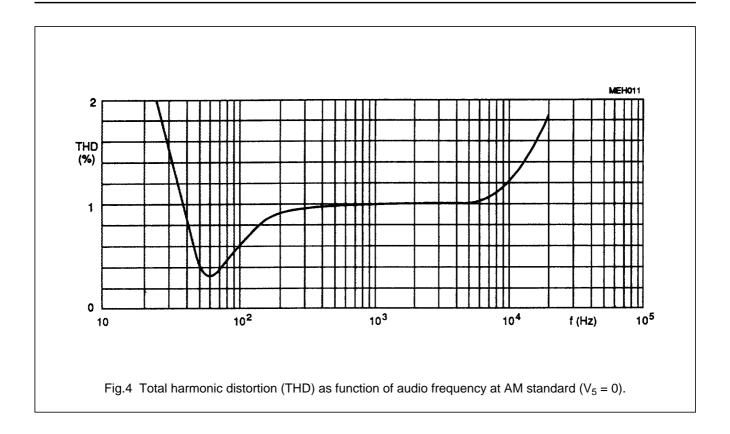
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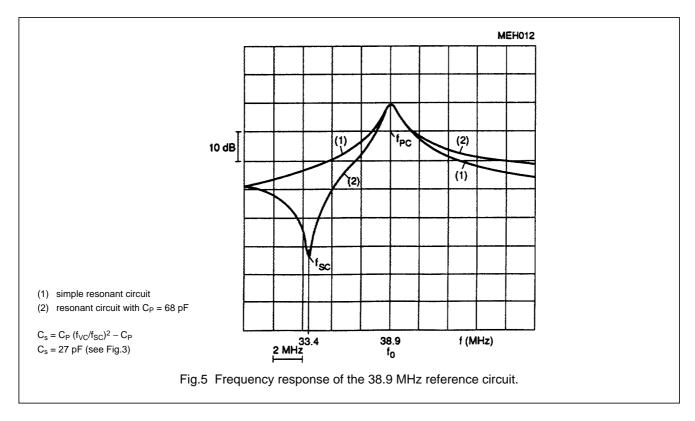
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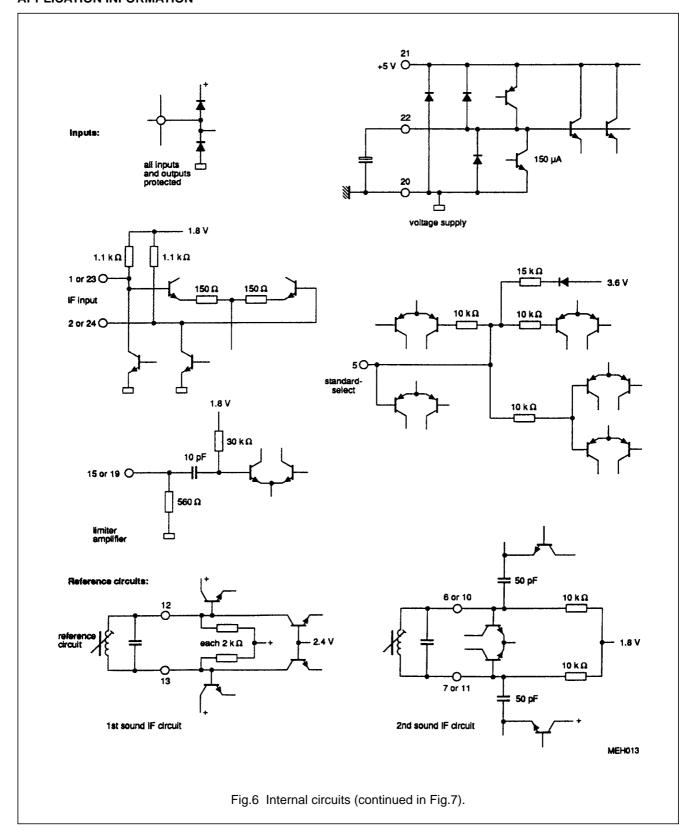




# Quasi-split sound processor for all standards

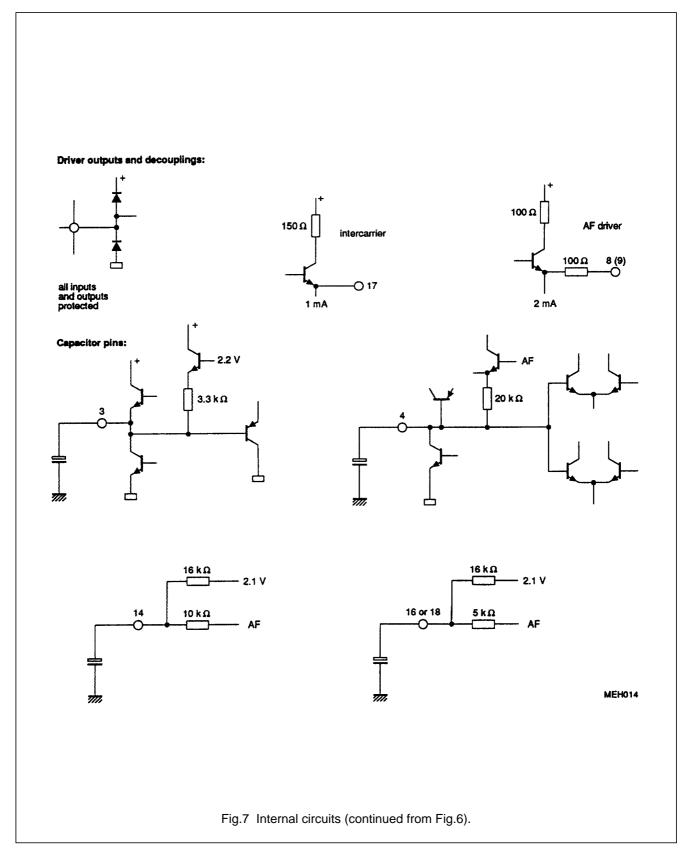
TDA3856

# **APPLICATION INFORMATION**



# Quasi-split sound processor for all standards

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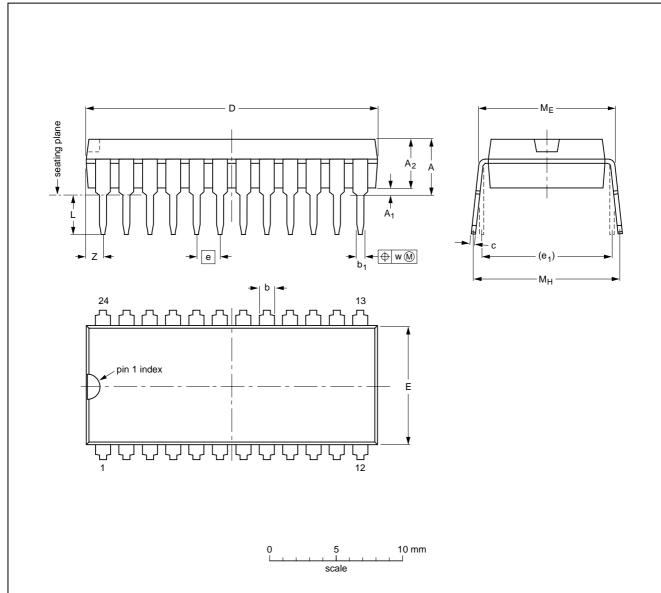
# Quasi-split sound processor for all standards

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# **PACKAGE OUTLINES**

# SDIP24: plastic shrink dual in-line package; 24 leads (400 mil)

SOT234-1



# **DIMENSIONS** (mm are the original dimensions)

|      |           |                        | J                      |            |                |              |                  |                  |       |                |            |              |              |      |                          |
|------|-----------|------------------------|------------------------|------------|----------------|--------------|------------------|------------------|-------|----------------|------------|--------------|--------------|------|--------------------------|
| UNIT | A<br>max. | A <sub>1</sub><br>min. | A <sub>2</sub><br>max. | b          | b <sub>1</sub> | С            | D <sup>(1)</sup> | E <sup>(1)</sup> | е     | e <sub>1</sub> | L          | ME           | Мн           | w    | Z <sup>(1)</sup><br>max. |
| mm   | 4.7       | 0.51                   | 3.8                    | 1.3<br>0.8 | 0.53<br>0.40   | 0.32<br>0.23 | 22.3<br>21.4     | 9.1<br>8.7       | 1.778 | 10.16          | 3.2<br>2.8 | 10.7<br>10.2 | 12.2<br>10.5 | 0.18 | 1.6                      |

### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

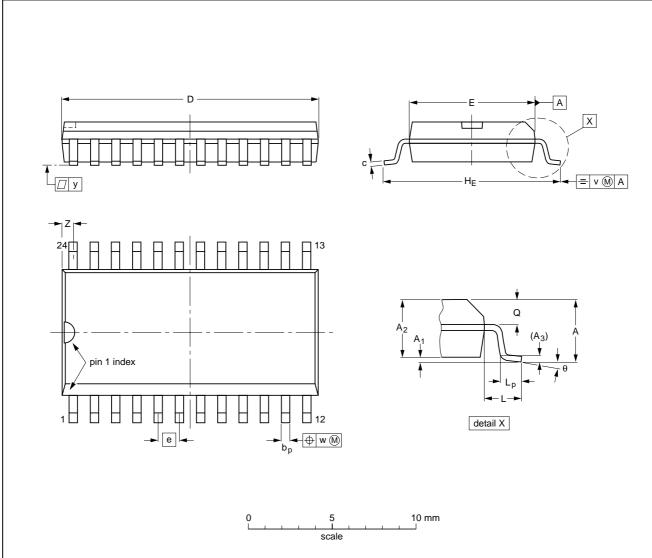
| OUTLINE  |     | REFER | EUROPEAN | ISSUE DATE |            |                                 |
|----------|-----|-------|----------|------------|------------|---------------------------------|
| VERSION  | IEC | JEDEC | EIAJ     |            | PROJECTION | ISSUE DATE                      |
| SOT234-1 |     |       |          |            |            | <del>92-11-17</del><br>95-02-04 |

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# SO24: plastic small outline package; 24 leads; body width 7.5 mm

SOT137-1



### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT   | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | bp             | С              | D <sup>(1)</sup> | E <sup>(1)</sup> | е     | HE             | L     | Lp             | Q              | v    | w    | у     | z <sup>(1)</sup> | θ  |
|--------|-----------|----------------|----------------|----------------|----------------|----------------|------------------|------------------|-------|----------------|-------|----------------|----------------|------|------|-------|------------------|----|
| mm     | 2.65      | 0.30<br>0.10   | 2.45<br>2.25   | 0.25           | 0.49<br>0.36   | 0.32<br>0.23   | 15.6<br>15.2     | 7.6<br>7.4       | 1.27  | 10.65<br>10.00 | 1.4   | 1.1<br>0.4     | 1.1<br>1.0     | 0.25 | 0.25 | 0.1   | 0.9<br>0.4       | 8° |
| inches | 0.10      | 0.012<br>0.004 | 0.096<br>0.089 | 0.01           | 0.019<br>0.014 | 0.013<br>0.009 | 0.61<br>0.60     | 0.30<br>0.29     | 0.050 | 0.419<br>0.394 | 0.055 | 0.043<br>0.016 | 0.043<br>0.039 | 0.01 | 0.01 | 0.004 | 0.035<br>0.016   | 0° |

### Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

| OUTLINE  |        | EUROPEAN | ISSUE DATE |            |                                 |
|----------|--------|----------|------------|------------|---------------------------------|
| VERSION  | IEC    | JEDEC    | EIAJ       | PROJECTION | ISSUE DATE                      |
| SOT137-1 | 075E05 | MS-013AD |            |            | <del>95-01-24</del><br>97-05-22 |

# Quasi-split sound processor for all standards

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### **SOLDERING**

### Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our "IC Package Databook" (order code 9398 652 90011).

### **SDIP**

SOLDERING BY DIPPING OR BY WAVE

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature ( $T_{stg\ max}$ ). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

# REPAIRING SOLDERED JOINTS

Apply a low voltage soldering iron (less than 24 V) to the lead(s) of the package, below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300  $^{\circ}$ C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400  $^{\circ}$ C, contact may be up to 5 seconds.

### SO

REFLOW SOLDERING

Reflow soldering techniques are suitable for all SO packages.

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement. Several techniques exist for reflowing; for example, thermal conduction by heated belt. Dwell times vary between 50 and 300 seconds depending on heating method. Typical reflow temperatures range from 215 to 250 °C.

Preheating is necessary to dry the paste and evaporate the binding agent. Preheating duration: 45 minutes at 45  $^{\circ}$ C.

### WAVE SOLDERING

Wave soldering techniques can be used for all SO packages if the following conditions are observed:

- A double-wave (a turbulent wave with high upward pressure followed by a smooth laminar wave) soldering technique should be used.
- The longitudinal axis of the package footprint must be parallel to the solder flow.
- The package footprint must incorporate solder thieves at the downstream end.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder is 10 seconds, if cooled to less than 150 °C within 6 seconds. Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

# REPAIRING SOLDERED JOINTS

Fix the component by first soldering two diagonally-opposite end leads. Use only a low voltage soldering iron (less than 24 V) applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300  $^{\circ}$ C. When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320  $^{\circ}$ C.

# Quasi-split sound processor for all standards

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# **DEFINITIONS**

| Data sheet status   |   |
|---|---|
| Objective specification   | This data sheet contains target or goal specifications for product development.       |
| Preliminary specification   | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification   | This data sheet contains final product specifications.                                |
| Limiting values   |   |
| Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability. |   |
| Application information   |   |
| Where application information is given, it is advisory and does not form part of the specification.   |   |

# LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.